



*Receipt*  
Patent

Case No.: 53415US038

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

First Named Inventor: **HARDY, L. CHARLES**

Application No.: **09/707,269**

Group Art Unit: **2825**

Filed: **November 6, 2000**

Examiner: **Caridad Everhart**

Title: **METHOD OF MODIFYING A WAFER SUITED FOR SEMICONDUCTOR  
FABRICATION**

**REQUEST FOR CORRECTED FILING RECEIPT**

Office of Initial Patent Examination's  
Customer Service Center  
Commissioner for Patents  
Washington, DC 20231

Dear Sir:

The Filing Receipt for the above-identified application contains one or more photocopy of the Filing Receipt with the correction(s) noted thereon is enclosed.

Please correct the Filing Receipt to include all the priority data as stated below:

THIS APPLICATION IS A CONTINUATION OF 09/091,932, FILED JUNE 24, 1998; WHICH IS A 371 OF PCT/US/98/08693, FILED APRIL 30, 1998, WHICH IS A CONTINUATION-IN-PART OF 08/846,726, FILED APRIL 30, 1997

Correction of the records at the United States Patent and Trademark Office and issuance of a corrected Filing Receipt are respectfully requested

Respectfully submitted,

November 1, 2002  
Date

By:

Colene H. Blank  
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Office of Intellectual Property Counsel  
3M Innovative Properties Company  
P.O. Box 33427  
St. Paul, MN 55133-3427

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53415US038 CORRECT FILING RECEIPT

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APPLICATION NUMBER	FILING DATE	GRP ART UNIT	FIL FEE REC'D	ATTY. DOCKET NO	DRAWINGS	TOT CLAIMS	IND CLAIMS
09/707,269	11/06/2000	2825	710	53415USA8C.038		20	1

OFFICE OF INTELLECTUAL PROPERTY COUNSEL  
3M INNOVATIVE PROPERTIES COMPANY

CONFIRMATION NO. 9169

Office of Intellectual Property Counsel  
3M Innovative Properties Company  
P.O. Box 33427  
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JAN 15 2001

FILING RECEIPT



\*OC000000005656774\*

REFERRED TO CHB

Date Mailed: 01/05/2001

Receipt is acknowledged of this nonprovisional Patent Application. It will be considered in its order and you will be notified as to the results of the examination. Be sure to provide the U.S. APPLICATION NUMBER, FILING DATE, NAME OF APPLICANT, and TITLE OF INVENTION when inquiring about this application. Fees transmitted by check or draft are subject to collection. Please verify the accuracy of the data presented on this receipt. If an error is noted on this Filing Receipt, please write to the Office of Initial Patent Examination's Customer Service Center. Please provide a copy of this Filing Receipt with the changes noted thereon. If you received a "Notice to File Missing Parts" for this application, please submit any corrections to this Filing Receipt with your reply to the Notice. When the PTO processes the reply to the Notice, the PTO will generate another Filing Receipt incorporating the requested corrections (if appropriate).

Applicant(s)

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Heather K. Kranz, St. Paul, MN;  
Thomas E. Wood, St. Paul, MN;  
L. Charles Hardy, St. Paul, MN;

Continuing Data as Claimed by Applicant

THIS APPLICATION IS A CON OF 09/091,932 06/24/1998  
WHICH IS A 371 OF PCT/US98/08693 04/30/1998

WHICH IS A CONTINUATION-IN-PART OF 08/846,726, FILED 04/30/1997

Foreign Applications

If Required, Foreign Filing License Granted 01/05/2001

Projected Publication Date:

Non-Publication Request: No

Early Publication Request: No

Title

Method of modifying a wafer suited for semiconductor fabrication

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Bib Data Sheet

CONFIRMATION NO. 9169

<b>SERIAL NUMBER</b> 09/707,269	<b>FILING DATE</b> 11/06/2000 <b>RULE</b>	<b>CLASS</b> 438	<b>GROUP ART UNIT</b> 2825	<b>ATTORNEY DOCKET NO.</b> 53415USA8C.038
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**APPLICANTS**

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~~Thomas E. Wood, St. Paul, MN;~~  
 L. Charles Hardy, St. Paul, MN;

**\*\* CONTINUING DATA \*\*\*\*\***

This application is a CON of 09/091,932 06/24/1998 PAT 6,194,317  
 which is a 371 of PCT/US98/08693 04/30/1998  
 which is a CIP of 08/846,726 04/30/1997 ABN

**\*\* FOREIGN APPLICATIONS \*\*\*\*\*****IF REQUIRED, FOREIGN FILING LICENSE GRANTED****\*\* 01/05/2001**

Foreign Priority claimed <input type="checkbox"/> yes <input type="checkbox"/> no	<b>STATE OR COUNTRY</b> MN	<b>SHEETS DRAWING</b>	<b>TOTAL CLAIMS</b> 20	<b>INDEPENDENT CLAIMS</b> 1
35 USC 119 (a-d) conditions met <input type="checkbox"/> yes <input type="checkbox"/> no <input type="checkbox"/> Met after Allowance				
Verified and Acknowledged	Examiner's Signature	Initials		

**ADDRESS**

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**TITLE**

Method of modifying a wafer suited for semiconductor fabrication

<b>FILING FEE RECEIVED</b> 710	FEES: Authority has been given in Paper No. _____ to charge/credit DEPOSIT ACCOUNT No. _____ for following:	<input type="checkbox"/> All Fees
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